DESIGN METHODS, TRANSISTOR MODELING, AND NUMERICAL SIMULATION OF LOW PHASE NOISE OSCILLATORS

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Must the design methods of low phase noise oscillators be revisited?

- New design methods allowing to clarify design process, are regularly proposed.
- New deep insights on phase noise generation in free running oscillators, are regularly presented.
- New accurate models of transistors and their associated noise sources, are continually developed.
OUTLINE

- Introduction
  • Design objectives for low-noise operation
- Modern linear design approach
  • A simplified transistor model, valid for FETs and HBTs
  • Open-loop gain concept: calculation of the starting oscillation frequency
  • Fast analytic calculation of phase noise: Leeson formula revisited
- Nonlinear models and design tools

• Semi-conductor device modeling:
  - Large signal models of FETs and HBTs

• Noise source modeling oriented to CAD of nonlinear circuits:
  - Low frequency noise sources
  - RF noise sources

• Simulation tools:
  - Steady state analysis
  - Local stability
  - Phase noise simulation
- Practical examples
  
  • Breadboard example
  
  • MMIC-based oscillators for high volume production

- Conclusion
Design objectives for low-noise operation

A well-designed oscillator requires the optimization of the circuit behavior:
- on the one hand at the oscillation-frequency (large signal)
- on the other hand at the intermodulation frequencies resulting from the interaction between (small signal) noise sources and (large signal) steady-state.

Fig. 1: Noise conversion in oscillators
Optimization objectives for low phase noise generation

- At the oscillation frequency : $\omega_0$
  
  • Maximization of the transistor added power

- Around the oscillation frequency :
  
  • Maximization of the phase slope of the oscillator open loop gain

- At low-frequencies near DC:
  
  • The impedance presented by the oscillator circuit and the bias network must be low in order to reduce the influence of the transistor low-frequency noise sources on the phase noise.
Modern linear design approach

• A simplified transistor model:

From a circuit-design point of view, a transistor is fundamentally a non-linear voltage-controlled current source.

The controlling voltage is taken at a diode port: forward biased in HBTs and reverse biased in HEMTs. Due to the highly nonlinear equivalent capacitance of this input diode, the phase noise generation by up conversion takes place principally at this controlling voltage port.
• A linearization of the nonlinear model gives the linear simplified model:

\[ \tilde{V}_{in}(\omega) \rightarrow G_{in} \rightarrow C_{in} \downarrow \rightarrow G_{mo} \cdot V_{in}(\omega) \rightarrow G_{out} \]

This model can be used for a first linear analysis of an oscillator circuit:

Includes the output load
• The open loop gain concept:

\[ \tilde{G}_{OL} = \text{open loop gain} = \frac{\tilde{V}_{\text{in}}(\omega)}{\tilde{E}_{\text{ext}}(\omega)} \]
- In a first small signal approximation, the oscillation frequency is given for the conditions

\[
\begin{align*}
|\tilde{G}_{OL}(\omega_O)| &> 1 \\
\varphi_{OLG}(\omega_O) &= \angle \tilde{G}_{OL}(\omega_O) \approx 0
\end{align*}
\]

\[\Rightarrow |\tilde{G}_{OL}| > 1 : \text{During the transient } \tilde{G}_{OL} \text{ reduces to a large signal operating point where } |\tilde{G}_{LS}(\omega_O)| = 1
\]

\[\Rightarrow \varphi_{OLG}(\omega_O) = \angle \tilde{G}_{OL}(\omega_O) \approx 0 : \text{During the transient } \varphi_{OLG}(\omega) \text{ shift in frequency to the operating point where } \varphi_{LS}(\omega_O) = 0 \text{ and :}
\]

\[\omega_{O_{\text{large signal}}} \approx \omega_{O_{\text{small signal}}}
\]
Simulation results of linear open-loop gain for an MMIC HEMT oscillator

Simulation results of linear open-loop gain for an MMIC HEMT oscillator with circuit stabilization
Simulation results of linear-loop gain for a transistor oscillator.

Question: Are the previous conditions sufficient to find a stable oscillation?

Answer: No, the local stability of the large signal operating point must be analyzed.

⇒ See section “Non linear simulation tool”
A first response can be given by the linear analysis

If:

$$
\begin{align*}
\left| G_{OL}(\omega_0) \right| &> 1 \\
\varphi_{OL}(\omega_0) &= \angle G_{OL}(\omega_0) = 0 \\
\left. \frac{d\varphi_{OL}}{d\omega} \right|_{\omega_0} &< 0
\end{align*}
$$

Then the final steady-state oscillation should be stable.
Linear evaluation of phase noise in free running oscillators:

- A useful tool: The modified Leeson formula

In the field of linear feedback-systems formalism, the Leeson formula is a useful tool for the determination of phase noise in feedback oscillators.

A direct application of the Leeson model without care, can lead to erroneous results because the formula contains hidden parameters which are generally unwittingly ill-evaluated, or neglected.

A detailed analysis enables us to enlighten the hidden parameters leading to a modified Leeson formula which is valid for all oscillator circuits.
This general representation of a feedback oscillator includes:
- the amplifying device: the transistor
- the feedback path, which includes the load conductance

A linear representation (after nonlinear equivalent linearization) of the feedback oscillator in the frequency domain allows to highlight:

The amplifying (active) function of the transistor: the voltage controlled current source of the transistor is isolated $G_{M0}V_1$ from the passive elements of the transistor model, which are now included in the passive, reciprocal feedback path.

For phase noise calculation purposes a carrier voltage of peak value $V_{01}$ at the oscillation frequency $\omega_0$ is implied at the controlling input port of the transistor.
Feedback oscillator with a chain matrix description of the passive circuit

One noise source alone is not always sufficient to characterize a noisy transistor.

However in the most general case two correlated sources:
- $I_{n_{input}}$ and $I_{n_{input}}$ are sufficient.

In that case $\langle |n|^2 \rangle$ becomes

$$\langle |n|^2 \rangle = \langle |I_{n_{input}}|^2 \rangle + \langle |I_{n_{input}}|^2 \rangle + 2\Re\left( I_{n_{input}}^* I_{n_{input}} \right)$$

For phase noise calculation, this input noise source must be carefully evaluated according to the localization of the physical noise sources in the transistor.
Determination of $S_{\Delta \phi_{\text{in}}}$

In the field of linear feedback system formalism, the equivalent closed loop representation of the figure below is deduced. In this figure, we have: $G_{M0}V_1 = I_{\text{out}}, V_2 = V_{\text{out}}$, $V_n$ represents the equivalent input noise voltage source due to $I_n$.

In order to determine $S_{\Delta \phi_{\text{in}}}$, we first calculate $V_n$ around the oscillation frequency $\omega_o$.

Let $\omega_n = \omega_o + \Delta \omega$

We obtain

$$\left\langle |V_n|^2 \right\rangle = \left\langle |I_n|^2 \right\rangle \left| \frac{A_0}{C_0} \right|^2$$

$A_o$ and $C_o$ are the chain-matrix coefficients taken at $\omega_o$.
Determination of $S_{\Delta \phi_{\text{in}}}$ (continued)

A conventional treatment shows that by addition to a pure carrier signal of peak value $V_{o1}$ at the frequency $\omega_o$, two uncorrelated components at $\omega_o + \Delta \omega$ and $\omega_o - \Delta \omega$ give rise to a modulated carrier with a phase-noise spectral density $S_{\Delta \phi_{\text{in}}}$.

At an offset frequency $\Delta \omega$ from the carrier, we obtain

$$S_{\Delta \phi_{\text{in}}}(\Delta \omega) = 2 \frac{\langle V_n^2 \rangle}{V_{o1}^2}$$

Finally we obtain a white phase-noise spectral density in a 1-Hz bandwidth

$$S_{\Delta \phi_{\text{in}}} = 2 \frac{\langle I_n^2 \rangle A_0^2}{V_{o1}^2 c_0^2} = 2 \frac{S_{I_n}}{V_{o1}^2 c_0^2} A_0^2$$
Determination of the oscillation frequency

In order to find the oscillation frequency, by setting $I_n = 0$ and opening the feedback loop, the figure below is obtained.

\[ V_{out} = \frac{1 - BGM0}{AGM0} \]

We have:

\[ G_{M0}V_{ext} = I_{out} \quad \text{and} \quad -\frac{I_{out}}{C} = V_1 \]

The open-loop gain can be written as:

\[ \tilde{G} = \frac{V_1}{V_{ext}} = -\frac{G_{M0}}{C} \]

Where $\tilde{G}$ denotes the complex gain in the frequency domain.
Determinance of the oscillation frequency (continued)

Oscillation conditions are fulfilled for $V_1 = V_{\text{ext}}$. It follows that:

$$\tilde{G}(\omega_0) = 1 - \frac{G_{M0}}{C} = -\frac{G_{M0}}{C_0}$$

Note that from the above expression $C_0$ must be real and negative.

Let $C = C_R + jC_I$,

The oscillation frequency is determined by:

$$C_I(\omega_0) = 0$$

and then $C_R(\omega_0) = C_0 = -G_{M0}$.
Determination of the “loaded Q factor of the oscillator”

The loop gain is written as:

$$\tilde{G} = |G|e^{j\varphi} = -\frac{GM0}{C}$$

At the oscillation frequency $\omega_0$

$$|G|_{(\omega_0)} = 1$$
$$\varphi(\omega_0) = 0$$

From $\tilde{G} = |G|e^{j\varphi} = -\frac{GM0}{C}$, the slope $\frac{d\varphi}{d\omega}$ of the loop gain can be obtained at the oscillation frequency as:
Determination of the “loaded Q factor of the oscillator” (continued)

\[ \frac{d\varphi}{d\omega} \bigg|_{\omega_0} = -\frac{C'}{C_0} \]

with \[ C'_I = \frac{dC_I}{d\omega} \bigg|_{\omega_0} \]

We denote the “oscillator loaded Q factor” \( Q_{\text{Loscill}} \) as

\[ Q_{\text{Loscill}}(\omega_0) = \frac{\omega_0}{2} \frac{d\varphi}{d\omega} \bigg|_{\omega_0} = \frac{\omega_0}{2} \frac{-C'_I}{C_0} \]

- Note as a general rule that the “oscillator loaded Q factor” \( Q_{\text{Loscill}} \) does not coincide with the loaded Q factor of the passive circuit.
- It coincides only for some elemental feedback networks.

The relevant coefficient for the calculation of the output phase noise: \( Q_{\text{Loscill}} \) is proportional to the group delay of the feedback path.
It is directly related to the phase-frequency relationship of the oscillator loop gain.
Determination of the output phase noise

The following normalized representation of the feedback oscillator can be deduced

We have successively:

\[ \Delta \phi_{in} = \Delta \phi_{out} \left( 1 - \frac{1}{1 + j \frac{C_I}{C_0} \Delta \omega} \right), \quad \Delta \phi_{out} = \Delta \phi_{in} \left( 1 - j \frac{C_0}{C_I} \Delta \omega \right), \quad S_{\Delta \phi_{out}} = S_{\Delta \phi_{in}} \left( 1 + \left( \frac{C_0}{C_I} \right)^2 \frac{1}{\Delta \omega^2} \right) \]

Explicitly, we obtain

\[ S_{\Delta \phi_{out}} = 2 \frac{\langle I_n \rangle^2}{V_{01}} \left( \frac{A_0}{C_0} \right)^2 \left( 1 + \left( \frac{C_0}{C_I} \right)^2 \frac{1}{\Delta \omega^2} \right) \]
Determination of the output phase noise (continued)

The near carrier frequency, $S_{\Delta \phi_{out}}$ becomes

$$S_{\Delta \phi_{out}} = 2 \left( \frac{\langle I_n^2 \rangle}{V_{01}^2} \right) A_0^2 \frac{1}{C'I} \frac{1}{\Delta \omega^2}$$

These equations must now be compared to the corresponding Leeson formulas recalled below:

$$S_{\Delta \phi_{out}} = S_{\Delta \phi_{in}} \left( 1 + \frac{\omega_0^2}{4Q_{Leeson}^2 \Delta \omega^2} \right)$$

and near carrier frequency

$$S_{\Delta \phi_{out}} = S_{\Delta \phi_{in}} \left( \frac{\omega_0^2}{4Q_{Leeson}^2 \Delta \omega^2} \right)$$

By comparison with the previous equations we have

$$Q_{Leeson}(\omega_0) = \frac{\omega_0}{2} \left| \frac{d \phi}{d \omega} \right|_{\omega_0} = \frac{\omega_0}{2} \left| \frac{-C'}{C_0} \right| = Q_{Loscill}(\omega_0)$$

The hidden parameters included in the Leeson formula, may result in a $Q_{Loscill}$ different from the loaded Q factor $Q_L$ of the feedback tank by more than one order of magnitude.
In order to account for such a possible difference, let us look at the following example.

![Diagram of a microwave oscillator circuit](image)

The circuit includes a dielectric resonator coupled by means of a lossless transmission line of characteristic impedance $Z_c$, and electrical length $\theta_R$ at the oscillation frequency. The purpose of introducing the line is to allow variation in the loaded Q factor of the oscillator (without simultaneously varying the resonant frequency or, at the first order, the loaded Q of the passive circuit) by the varying length $\theta_R$. 
A simplified linear schematic

with the electrical equivalent circuit
A closed loop representation can be deduced

\[
\begin{array}{c}
I_n \\
\frac{1}{Y_T} \quad e_n + \quad V_{in} \\
\times \quad G_{Mo} \\
\hline
\end{array}
\]

\[
V_{out} \quad - \quad \frac{N}{G_{Mo}} \quad \begin{array}{c}
N \\
Y_T \end{array}
\]

with \( Y_T = Y_f + G_{in} + N^2(G_{out} + G_L) \)

\( Y_f \) is the admittance of the whole resonator circuit brought back by the coupling line to the transistor input port.

Around the oscillation frequency, a straightforward calculation gives

\[
Y_f = G_C \left[ 1 + j \left( \frac{2C_c - \frac{\pi G_C}{2\omega_o}}{G_C} \right) \cos(2\theta_o) \Delta \omega \right]
\]

The term: \( 2C_c \) is due to the lumped resonator, and \( \frac{\pi G_C}{2\omega_o} \) is due to the open circuit stub.
Phase noise calculation

One can now represent the oscillator around the oscillation frequency $\omega_0$ by the normalized closed loop representation of the figure below.

The normalized transfer function around the oscillation frequency is written as:

$$H(\Delta \omega) = \frac{1}{1 - j \frac{d\phi}{d\omega} \Delta \omega} = \frac{1}{1 + j \left( \frac{2 \omega_0}{G_{tot}} \right) \cos(2 \theta_0) \Delta \omega}$$
The output phase noise is calculated as

\[ S_{\Delta \varphi_{out}} = S_{\Delta \varphi_{in}} \left\{ 1 + \left( \frac{G_{tot}}{2C_c - \frac{\pi G_c}{2\omega_o}} \right)^2 \cos^2(2\theta_o \Delta \omega^2) \right\} \]

From this equation, it can be shown that \( S_{\delta \varphi_{out}} \) is periodic with \( \theta_o \).

A numerical simulation confirms this result.

Phase noise has been successively simulated with two noise sources: a white noise source and 1/f noise source.
As expected, a phase noise roll-off, respectively of -20dB/dec and -30 dB/dec versus frequency offset from carrier is obtained.

Besides, for a fixed frequency offset, both noise sources give similar curves as a function of the electrical length: $\theta_o$

This fig. shows the results obtained at 100 kHz from carrier, with the white noise source: curve (a) is the analytical result and curve (b) is the simulation result.

Application of the Leeson formula gives a phase noise of -121 dBC practically constant as a function of $\theta_o$. Note that the unloaded Q factor of the resonator used was $Q_o=3000$. 
Note:

- The Q factor of the oscillator circuit defined as:

\[ Q_{oscill}(\omega_0) = \frac{\omega_0}{2} \left| \frac{d\varphi}{d\omega} \right|_{\omega_0} \]

Is not, as a general rule, equal to the Q factor of the circuit defined as:

\[ Q_{circuit}(\omega_0) = \omega_0 \frac{\bar{\varepsilon}}{P} \]
As an example, let us consider the following simple oscillator circuit:
The energy stored is:

- In the resonator coupling line

\[ \bar{\varepsilon}_{\text{line}} = \frac{1}{2} \frac{\theta_o}{Z_c \omega_o} |V_c(\omega_o)|^2 \]

- In the resonator:

\[ \bar{\varepsilon}_{\text{resonator}} = \frac{1}{2} C_R |V_c(\omega_o)|^2 \]

- Power dissipated:

\[ \bar{P} = \frac{1}{2} \left[ G_{\text{in}} + G_L + G_{\text{out}} \right] |V_c(\omega_o)|^2 = \frac{1}{2} G_{\text{tot}} |V_c(\omega_o)|^2 \]

Then,

\[ Q_L (\omega_o) = \omega_o \frac{\bar{\varepsilon}_{\text{tot}}}{\bar{P}} = \omega_o \left[ \frac{C_R + \frac{\theta_o}{Z_c \omega_o}}{G_{\text{tot}}} \right] \]
The loop gain phase slope around $\omega_o$ is

$$\left| \frac{d\varphi}{d\omega} \right|_{\omega_o} = \frac{2CR}{G_{tot}} \cos(2\theta_o)$$

and

$$Q_{oscill} = \frac{\omega_o}{2} \left| \frac{d\varphi}{d\omega} \right|_{\omega_o} = \omega_o \frac{CR}{G_{tot}} \cos(2\theta_o)$$

$Q_{oscill}$ is different from $Q_L$.

However for $\theta_o = 0$, $Q_{oscill} = Q_L$
Modeling of Semi-conductor devices

- Large signal models
- Noise sources

Large signal electrical models must be physically based in order to accurately take into account the interactions between the noise sources and the nonlinear elements in the semi-conductor devices.

The low frequency noise sources up converted near the oscillation frequency must be accurately localized in the semi-conductor devices.
The counter example

- Let us suppose $I_{n1}$ and $I_{n2}$ are two low frequency noise sources representing the L.F noise sources extracted from the transistor.

If this model was physically accurate, it would be sufficient to bias the transistor through two choke inductances in order to eliminate all possible up-conversions.
Unfortunately in nonlinear design, the noise sources must be localized exactly where they are generated.

An example of nonlinear distributed model of HEMT
In field-effect transistors, accurate modeling of the interaction between steady-state large signal and low-frequency noise sources distributed along the source-drain channel, requires a distributed model.

For this purpose, a non-linear, non-uniform, distributed model of FETs has been developed.

Nonlinear HEMT Model including the L.F noise sources of the channel
- The channel is considered as a non-uniform, non-linear, active transmission line with $N$ unit cells. The number of cells depends on the channel length and the operating frequency. A good compromise for microwave devices is $10 \leq N \leq 20$.

- Every unit cell includes:
  
  - A non-linear gate-channel capacitance: $C = f_C(V_{g_k})$ in parallel with a Schottky diode: $I = f_D(V_{g_k})$. These elements are a function of their own port voltage $V_{g_k}$.
  
  - A non-linear channel current-controlled source: $I_c = f_I(V_{g_k}, \Delta V_{c_k})$ which depends on the two cell-voltages: $\Delta V_{c_k}$ and $V_{g_k}$.
- The model has been extracted for many HEMTs from different processes. Figure 1 shows a comparison between the model and measured characteristics for a 4*0.25*50 μm PHEMT modeled with 10 unit-cells.

- It must be pointed out that:
  
  • The model is fully extracted from measurements.
  • The functions $f_c$, $f_G$, $f_t$ are identical for all unit cells.
  • The model reproduces the non-uniform non-quasi-static behavior of the transistor in a natural way.
MEASURED AND MODELED I-V CHARACTERISTIC

PH25 - 4 x 50 µm Vgs0 = -0.28 V, Vdso=2.51 V

Fig. 1: PH 25 Transistor distributed model

Note that such a distributed model including distributed noise sources has been recently proposed for MOSFETs.
Some bipolar transistor models including a distributed circuit (for the base region), have been proposed for linear applications (Te-Winkel, Pritchard, Van der Ziel,…)

However to our knowledge, nonlinear distributed models of HBTs suitable for CAD of nonlinear circuits have not been proposed.

This figure shows an example of HBT nonlinear model including the main noise sources used for CAD of oscillator circuits. Note that the circuit shows “possible localization of noise sources”. Fortunately many of them can be neglected, according to the technology.
Noise source modeling

– Physical noise sources:

<table>
<thead>
<tr>
<th>G-R Noise</th>
</tr>
</thead>
<tbody>
<tr>
<td>Fundamental 1/f noise</td>
</tr>
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Low-frequency noise sources

- Linear resistances
- FET-Channel
- Shot noise in SC junctions

RF noise sources: diffusion noise
Two physical sources of low-frequency noise must be considered:

- $\delta N(t)$: Random fluctuations of the carrier number: $N$
- $\delta \mu(t)$: Random fluctuations of the low-field mobility: $\mu_0$

• The first one is due to traps present in the semi-conductor.
• The second is named the “fundamental 1/f noise”, and applies also to the low-frequency fluctuations of the diffusion coefficient $\delta D(t)$.

One physical source of RF noise:

The diffusion noise gives rise to white noise sources:

- Low electric field: thermal noise
- High electric field: diffusion noise
- Noise of minority carriers in semi-conductor junctions: shot noise
LOCAL CURRENT- NOISE SOURCES IN HOMOGENEOUS LINEAR SAMPLES

- Let us consider a slice: $\Delta x$ with a cross-section: $A$, and a carrier concentration: $n_0$

- the velocity of carriers due to the deterministic local applied voltage: $\Delta V(t)$ writes:

$$V_c(t) = \mu_0 \frac{\Delta V(t)}{\Delta x}$$

- A deterministic current $I(t)$ follows:

$$I(t) = q \frac{N_0}{\Delta x} V_c(t) = \frac{q}{\Delta x^2} \Delta V(t) \cdot \mu_0 N_0$$

with $N_0 = n_0 \cdot A \cdot \Delta x$
- If low-frequency random fluctuations: $\delta N(t)$ and $\delta \mu(t)$ are present in the slice: $A.\Delta x$

  → Local Norton noise sources are given by:

  $$\delta i(t) = \frac{q}{\Delta x^2}.\Delta V(t).[\mu_0.\delta N(t) + N_0.\delta \mu(t)]$$

  \[DC+RF\]
  \[Deterministic\]
  \[applied\]  \[Low-frequency\]
  \[random\]  \[Low-frequency\]
  \[fluctuations\]  \[random\]  \[fluctuations\]

**Conclusion:** The initial low-frequency random fluctuations: $\delta N(t)$ and $\delta \mu(t)$ are “probed” by the DC+RF deterministic applied voltage, which results in Norton noise sources with the initial low-frequency spectrum transposed around the Fourier components of the deterministic applied voltage giving rise to cyclostationary noise sources.
RF noise:

Since Dragone, we have known that the diffusion noise with a $\delta$ correlation function is modulated by a large-signal periodic applied voltage.

- A local noise source described for a DC applied by its spectral density:

$$\langle \delta I^2(x) \rangle = 4q^2 \frac{Dn(x)}{A} \delta(x-x') \Delta f$$

- becomes cyclostationary when a periodic large signal is applied:

$$\langle \delta I^*_k(x) \delta I^*_j(x) \rangle = 4q^2 \frac{DN(k-j)}{A} \delta(x-x') \Delta f$$
Where \( N(k-j) \) is the \((k-j)\)th harmonic of \(n(x,t)\)

In other words:

In the presence of a large signal periodic electric field:
- the low frequency current noise sources
- and the RF current noise sources

Are modulated and create upper and lower side-bands around every harmonic component of the large signal periodic electric field.
An external DC Applied Voltage gives rise to:

- DC local current density into the S.C. device:
  \[ J_o(x) = q . N(x) . v(x) \rightarrow \text{DC} \]

L.F. random fluctuations of traps occupancy: \( N_T(x,t) \) gives:

- L.F. random fluctuations of free carriers: \( \delta N(x,t) \rightarrow \text{bulk} \)
- L.F. random fluctuations of velocity recombination: \( \delta v(x,t) \rightarrow \text{surface} \)

It results two main generations:

\[
\begin{align*}
N_T(x,t) & \rightarrow \delta N(x,t)_{\text{L.F.}} \rightarrow \delta N . v_{\text{L.F. DC}} \\
& \rightarrow \delta v(x,t)_{\text{L.F.}} \rightarrow \delta v . N_{\text{L.F. DC}}
\end{align*}
\]

L.F. bulk noise current source
L.F surface recombination noise current source
An external Large Signal Applied Voltage gives rise to:

- Large signal local current density into the S.C. device:
  \[ J(x,t) = qN(x,t)v(x,t) \]  DC and RF components

L.F. random fluctuations of traps occupancy: \( N_T(x,t) \) gives:

- L.F. random fluctuations of free carriers: \( \delta N(x,t) \) → bulk
- L.F. random fluctuations of velocity recombination: \( \delta v(x,t) \) → surface

It results two main generations:

\[ N_T(x,t) \]
\[ \frac{\delta N(x,t)}{L.F} \]
\[ \frac{\delta v(x,t)}{L.F} \]

Cyclostationary bulk noise current source
Cyclostationary surface recombination noise current source
A coherent set of robust and reliable simulation-tools is required in order to:

- Find the steady-state oscillation-frequency and variables at every node of the circuit.
- Perform a linear/non-linear stability analysis and find possible spurious frequencies.
- Calculate AM and PM noise spectrum.

→ Steady-state analysis is generally performed using the well-established harmonic-balance method.
A simplified NL local stability analysis:

→ The linear/non-linear stability analysis may now be easily performed with commercially available software packages.

The figure below shows the principle of the non-linear open loop concept applied to a HEMT oscillator circuit, for stability analysis purposes.

Modified transistor model for stability analysis
The open loop gain $\tilde{G}(\Omega) = \frac{V_{gs}(\Omega)}{E(\Omega)}$ is calculated and its module and phase are plotted as a function of frequency.

Note that these plots are equivalent to the plot drawn in the linear case for the determination of the oscillation frequency

(See section: Modern linear design approach)
Steady-state analysis

- Modern harmonic balance software packages include:
  
  • Modified nodal analysis formulation to describe the circuit
  
  • Krylov subspace methods to solve the network matrices

- Conditions for a successful steady-state simulation:
  
  • High number of spectral components

    → High number should lead to high accuracy, but
• Are the models of passive elements and active devices valid at very high frequencies?

Solution: Short-circuit at the active device ports for $f > N f_0$
N: depending on the foundry models.

• Are the number of samples of the time-domain state variables sufficient?

Solution: Accurate results need oversampling

Conclusion:
Special care is needed in choosing the number of spectral components as well as the number of time domain samples.

(See example below)
Simulation of phase noise in oscillators

- Accurate simulation needs to take into account:

  • All kind of noise sources localized at every node of the circuit:
    - at low frequency
    - or RF frequency

  • linear, and cyclostationary noise sources.

  • must take also into account the low-frequency dynamics of the oscillator circuit and bias network (see example below)
- Accurate modeling of the noise sources:

  • Current models are generally not sufficient

  There is a confusion between:

  - Models valid only for linear applications

  - Models whose validity extends to nonlinear applications

  - The localization of the noise sources in the nonlinear device models is still only approximated.
Oscillator phase noise calculation in the frequency domain by means of conversion matrices formalism

- output waveform:

\[ V(t) = V_o \left[ 1 + \frac{\Delta v(t)}{V_o} \right] \cos(\omega_o t + \phi_o + \Delta \phi(t)) \]

\[ V_o \] Peak amplitude of the carrier \( \omega_o \)

\[ \phi_o \] A constant phase

\( \Delta v(t) \) Amplitude noise modulation

\( \Delta \phi(t) \) Phase noise modulation
- At a frequency offset $\Omega$, from carrier:

AM and PM noise modulations are expressed as pseudosinusoids

$$\Delta v(t) = \Delta V_o \cos(\Omega t + \Phi_A)$$

$$\Delta \varphi(t) = \Delta \varphi_o \cos(\Omega t + \Phi_\phi)$$

Where $\langle \Delta v(t)^2 \rangle$ and $\langle \Delta \varphi(t)^2 \rangle$ denote their associated spectral densities; $\Delta V_o, \Delta \varphi_o, \Phi_A, \Phi_\phi$ are random variables.

We can write $V(t)$ as:

$$V(t) = V_o \left[ \cos(\omega_o t + \varphi_o) + \frac{V_o}{\Delta} \cos(\omega_o - \Omega t + \varphi) + \frac{V_o}{\Sigma} \cos(\omega_o + \Omega t + \varphi) \right]$$
Let’s write \[ \frac{\Delta V_o e^{j\phi A}}{V_o} = \Delta \tilde{V} \]

\[ \Delta \phi_o e^{j\phi} = \Delta \tilde{\phi} \]

\[ V_\Delta e^{j\phi} \Delta = \Delta \tilde{V}_\Delta \]

\[ V_\Sigma e^{j\phi} \Sigma = \Delta \tilde{V}_\Sigma \]

We obtain:

\[ \text{AM noise} = \frac{P_{\text{AMtot}}}{P_{\text{carrier}}} = \frac{\langle |\Delta \tilde{V}|^2 \rangle}{\left\langle \frac{V_o^2}{2} \right\rangle} = S_A = \frac{V_\Delta^2}{V_o^2} \]

\[ \text{PM noise} = \frac{P_{\text{PMtot}}}{P_{\text{carrier}}} = \frac{\langle |\Delta \tilde{\phi}|^2 \rangle}{\left\langle \frac{V_o^2}{2} \right\rangle} = S_\phi = \frac{V_\Sigma^2}{V_o^2} \]

where

\[ V_\Delta = V(\omega_o - \Omega) \]

\[ V_\Sigma = V(\omega_o + \Omega) \]
The AM and PM noise are defined as:

\[
\text{AM noise} \quad \frac{N}{C} \text{at } \Omega \text{ dBC} = 10 \log \frac{P_{ssb}^{(AM)}}{P_{carrier}} \text{ by Hertz}
\]

\[
\text{PM noise} \quad L \text{ at } \Omega \text{ dBC} = 10 \log \frac{P_{ssb}^{(PM)}}{P_{carrier}} \text{ by Hertz} = \frac{S\phi}{2}
\]

\(\tilde{V}_\Delta, \tilde{V}_\Sigma, V_o, \varphi_o\) are calculated using the harmonic balance and its related technique: the conversion matrices formalism
RELATION BETWEEN STEADY-STATE ACCURACY ($\varepsilon$) AND PHASE NOISE RESULTS

$$\varepsilon = f (NH, Nt, \delta\omega_0)$$

$\varepsilon < \varepsilon < \varepsilon < \varepsilon$

Accurate PM noise calculation is directly related to the large steady-state accuracy.

It is only a numerical problem which is solved by an appropriate choice of:
- number of harmonics
- oversampling
Conversion matrices formalism

– allows to handle large signal/small signal interactions in nonlinear devices with good accuracy

– very efficient for noise calculation in nonlinear circuits driven by a periodic/quasi-periodic large signal:

• mixers
• converters
• oscillators
- Principle of Conversion matrices

Let us consider a nonlinear element described by its constitutive equation:

\[ y(t) = f(x(t)) \]

Examples: - Nonlinear conductance I/V
- Nonlinear capacitance Q/V

In small-signal applications around a bias point \( X_0 \):

\[
\delta y(t) = \frac{df}{dx} \bigg|_{X_0} \delta x(t) = h_o \delta x(t)
\]

\( h_o \) : constant, time invariant
- If $X_o$ becomes a periodic time varying bias point when a large signal of fundamental frequency $\omega_o$ is applied:

$$X_o \rightarrow X(t) = \sum_{-N}^{+N} X_k e^{jk\omega_o t}$$

Then:

$$h_o \rightarrow h(t) = \sum_{-N}^{+N} H_k e^{jk\omega_o t}$$

- If the small signal $\delta x(t)$ contains an input frequency: $\Omega$

Intermodulation components are generated at frequencies:

$$k\omega_o \pm \Omega$$
In the frequency domain $\delta x(t)$ and $\delta y(t)$ are expanded as:

$$\delta \tilde{X}(\omega) = \begin{bmatrix}
\delta x^*(N\omega_0 - \Omega) \\
\delta x^*(k\omega_0 - \Omega) \\
\delta x(\Omega) \\
\delta x(k\omega_0 + \Omega) \\
\delta x(N\omega_0 + \Omega)
\end{bmatrix}$$

and

$$\delta \tilde{Y}(\omega) = \begin{bmatrix}
\delta y^*(N\omega_0 - \Omega) \\
\delta y^*(k\omega_0 - \Omega) \\
\delta y(\Omega) \\
\delta y(k\omega_0 + \Omega) \\
\delta y(N\omega_0 + \Omega)
\end{bmatrix}$$

Then by identification with: $\delta y(t) = h(t)\delta(x(t))$
A matrix relation is found in the frequency domain:

$$
\delta \vec{Y}(\omega) = [H] \delta \vec{X}(\omega)
$$

with:

$$[H] = \begin{bmatrix}
H_0 & H_1^* & H_2^* & \cdots & H_{2N}^* \\
H_1 & H_0 & H_1^* & \cdots & H_{2N-1}^* \\
H_2 & H_1 & H_0 & \cdots & H_{2N-2}^* \\
\vdots & \vdots & \vdots & \ddots & \vdots \\
H_{2N} & H_{2N-1} & \cdots & \cdots & H_0
\end{bmatrix}
$$

$[H]$ is the conversion matrix of the nonlinear element.
- The variable \( \delta X(\omega) \) and the resulting function \( \delta Y(\omega) \) at each mixing frequency are related by the \textit{conversion matrix}.

- Since the relation between \( \delta \tilde{X}(\omega) \) and \( \delta \tilde{Y}(\omega) \) is linear (Matrix form), it results that the nonlinear devices appear as a linear periodic time varying element:

\[
y(t) = f(x(t)) \quad \rightarrow \quad \delta \tilde{y}(\omega) = [H] \delta \tilde{x}(\omega)
\]

Nonlinear element becomes L.P.T.V. element

Noise analysis can be performed using the conversion matrices formalism when the large signal is applied at the oscillation frequency \( \omega_o \) and its harmonic frequencies.
For example, we recall the phase noise expression:

\[
S_\phi = \frac{\left( \begin{array}{c}
\tilde{V}_\Delta e^{j\phi_o} - \tilde{V}_\Sigma e^{-j\phi_o} \\
\tilde{V}_\Delta e^{-j\phi_o} - \tilde{V}_\Sigma e^{j\phi_o}
\end{array} \right)^2}{V_o^2}
\]

- first: \(V_o, \phi_o\) of the noiseless oscillator are computed by harmonic balance.

- secondly: \(\tilde{V}_\Delta\) at \(\omega_o - \Omega\) and \(\tilde{V}_\Sigma\) at \(\omega_o + \Omega\) due to internal noise sources, are computed by the conversion matrices method.
Noise correlation matrix concept

- Introduced for several linear noise sources by H.A Haus and R.B. Adler: 1956

- One internal physical source at a frequency $\Omega$ gives rise to several equivalent external correlated noise sources at the same frequency $\Omega$
The correlation matrix at the given frequency $\Omega$ writes:

$$
C(\Omega) = \\
\begin{bmatrix}
\langle |I_{n1}(\Omega)|^2 \rangle & \langle I_{n1}(\Omega)I_{n2}^*(\Omega) \rangle & \langle I_{n1}(\Omega)I_{n3}^*(\Omega) \rangle \\
\langle I_{n2}^*(\Omega)I_{n1}(\Omega) \rangle & \langle |I_{n2}(\Omega)|^2 \rangle & \langle I_{n2}(\Omega)I_{n3}^*(\Omega) \rangle \\
\langle I_{n3}^*(\Omega)I_{n1}(\Omega) \rangle & \langle I_{n3}^*(\Omega)I_{n2}(\Omega) \rangle & \langle |I_{n3}(\Omega)|^2 \rangle \\
\end{bmatrix}
$$

The correlation matrix of several linear noise sources describes the auto-correlation and cross-correlation between them at a frequency $\Omega$. 
Noise correlation matrix concept (continued)

• Extension to cyclostationary noise sources:
  - The correlation matrix of a cyclostationary noise source describes the auto-correlation and cross correlation between the noise components at different frequencies: \( k\omega_o \pm \Omega \) and \( p\omega_o \pm \Omega \), of a single noise source.
  - The correlation matrix of several noise sources describes the auto-correlation and cross correlation of noise components at different frequencies of several correlated cyclostationary noise sources.
Two examples of phase noise calculation:

A basic oscillator circuit:

![Oscillator Circuit Diagram](image)
An oscillator circuit showing the influence of the low-frequency dynamics of the bias network.
Practical examples

• Breadboard example
The analytical expression shows that $S_{\Delta \Phi_{\text{out}}}$ varies periodically with $\theta_1$.

Simulation of a complete circuit, including a nonlinear model of HEMT and accurate models of passive elements shows the same variation.

Finally, experimental results performed on a breadboard circuit, made with commercially available components give the following conclusion.
In this experiment:

- the loaded Q of the passive circuit is maintained constant
- the variable is $\theta_1$, electrical length of the input resonator coupling line

Following the modified Leeson formula, we have:

$$
S_{\Delta \phi_{in}} = K \left| 1 - \left[ -\frac{1}{G_p} \right] e^{-2j\theta_1} \right|
$$

where:
- $G_p$ is the transistor gain
- $K$ is a coefficient independent of $\theta_1$
Output phase noise spectral density versus the electrical length $\theta_1$ of transmission line in the feedback path.

$LPMO$ Phase noise measurement setup

P_{oscil}=-6\text{dBm et } F_0=9.145\text{GHz constants}

$S_\phi @ 100\text{Hz} = -80\text{dBc}$

-30dB/decade

the reference oscillator noise
• MMIC-based oscillators for high volume production

Circuits presented have been designed in an industrial environment using the tools presented in this talk.

DRO with the external DR

<table>
<thead>
<tr>
<th>Measure</th>
<th>Measure</th>
<th>Simulation</th>
</tr>
</thead>
<tbody>
<tr>
<td>Auxiliary output power (dBm)</td>
<td>-12.4</td>
<td>-12.5</td>
</tr>
<tr>
<td>Oscillation frequency (GHz)</td>
<td>18.99</td>
<td>18.97</td>
</tr>
</tbody>
</table>
DRO PHASE NOISE SPECTRUM

\[ L_f (\text{dBc/Hz}) \]

Offset from carrier @ 19 GHz

-115 dBc/Hz
VCO MMIC 38.25 GHz (I)

RÉSONATEUR (imprimé)
$Q_0 \approx 80$

OCT : 12.75 GHz
×3
38.25 GHz

VCO with an external printed resonator

4 Transistors : 2×30 µm, 4×50 µm (×2), 4×75 µm
VCO MMIC 38.25 GHz (II)

Output power (dBm)

Frequency (GHz)

Measures
Simulation
Phase noise $\phi_f$ (dBc/Hz)

Offset from carrier @ 38.25 GHz

Simulation
Measurement

-79 dBc/Hz
CONCLUSION

- The key-aspects of the design of low phase-noise RF, microwave, and millimetre-wave transistor-oscillators have been presented.

- The modern linear analysis of oscillator circuits has been detailed.

- Accurate non-linear models of transistors have been described.

- Modeling of low-frequency noise sources has been discussed.

- We have presented advanced design tools and methods, used in an industrial environment, making design reliable and leading to reproducible electrical characteristics.

- In conclusion, rapid developments of new methods, models, and tools, constrain the designer to systematically revisit his own design methodology.
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